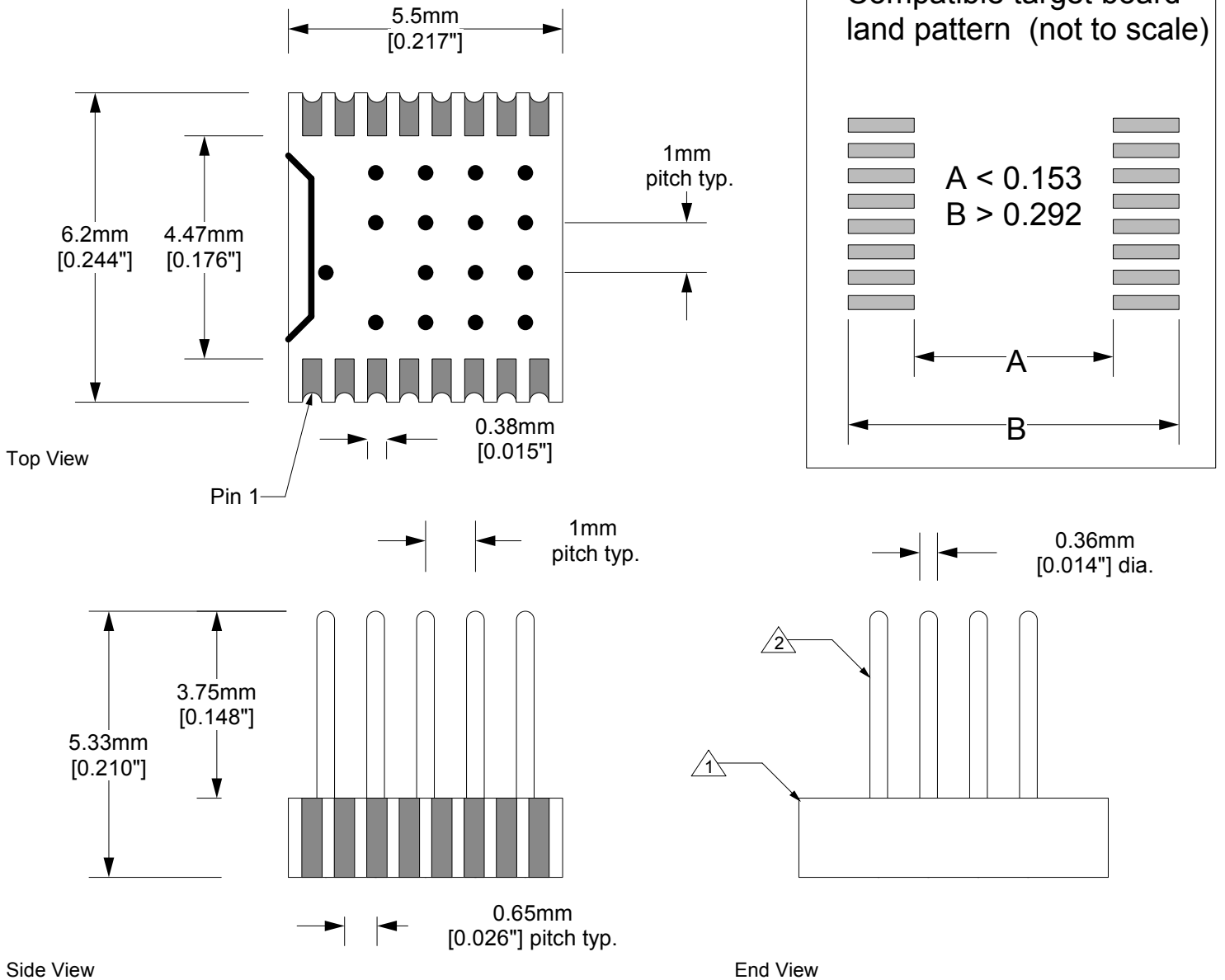


RoHS COMPLIANT




△1 Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] per IPC 4101/21/26/83/98, Td>=345C. Finish: silver (Ag) per IPC4553

△2 Pins: material- Brass Alloy 360 1/2 hard; finish- 0.25µm [10µ"] Au over 1.27µm [50µ"] Ni (min.).

Description: SSOP Surface Mount Emulator Foot

16 position 0.65 mm pitch leadless surface mountable emulator foot with micro grid array (UGA) pin interface.

Tolerances: diameters ±0.03mm [±0.001"], PCB perimeters ±0.13mm [±0.005"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

	SF-SO16D-L-01 Drawing	Status: Released	Scale: 8:1	Rev: B
	© 2005 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: E Smolentseva		Date: 10/24/05
		File: SF-SO16D-L-01 Dwg.mcd		Modified: 12/2/05, ELS